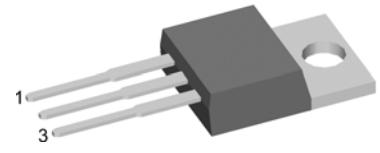
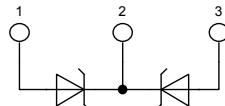


## Schottky Diode Gen 2

High Performance Schottky Diode  
Low Loss and Soft Recovery  
Common Cathode

### Part number

DSA 30 C 150 PB



Backside: cathode

### Features / Advantages:

- Very low  $V_f$
- Extremely low switching losses
- low  $I_{rm}$  values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

### Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

### Package:

- Housing: TO-220
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

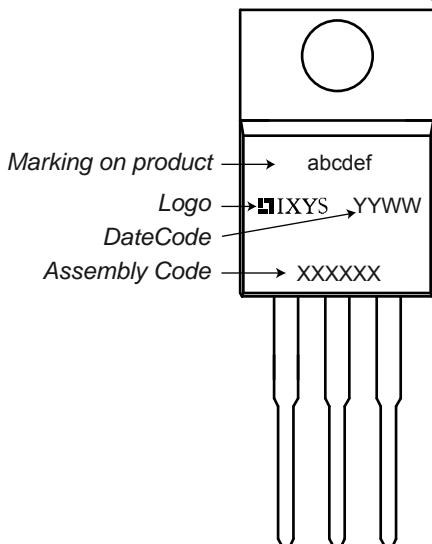
Symbol	Definition	Conditions		Ratings		
		min.	typ.	max.	Unit	
$V_{RRM}$	max. repetitive reverse voltage			150		V
$I_R$	reverse current	$V_R = 150\text{V}$	$T_{VJ} = 25^\circ\text{C}$		0.5	mA
		$V_R = 150\text{V}$	$T_{VJ} = 125^\circ\text{C}$		2.5	mA
$V_F$	forward voltage	$I_F = 15\text{A}$	$T_{VJ} = 25^\circ\text{C}$		0.89	V
		$I_F = 30\text{A}$			1.02	V
		$I_F = 15\text{A}$	$T_{VJ} = 125^\circ\text{C}$		0.75	V
		$I_F = 30\text{A}$			0.89	V
$I_{FAV}$	average forward current	rectangular	$d = 0.5$	$T_c = 150^\circ\text{C}$		A
$V_{FO}$ $r_F$	threshold voltage slope resistance } for power loss calculation only			$T_{VJ} = 175^\circ\text{C}$	0.55	V
					8.8	mΩ
$R_{thJC}$	thermal resistance junction to case				1.75	K/W
$T_{VJ}$	virtual junction temperature			-55	175	°C
$P_{tot}$	total power dissipation			$T_c = 25^\circ\text{C}$	85	W
$I_{FSM}$	max. forward surge current	$t = 10\text{ ms}$ (50 Hz), sine		$T_{VJ} = 45^\circ\text{C}$	120	A
$C_J$	junction capacitance	$V_R = 24\text{V}; f = 1\text{ MHz}$		$T_{VJ} = 25^\circ\text{C}$	82	pF
$E_{AS}$	non-repetitive avalanche energy	$I_{AS} = 1\text{A}; L = 100\text{ }\mu\text{H}$		$T_{VJ} = 25^\circ\text{C}$	0.05	mJ
$I_{AR}$	repetitive avalanche current	$V_A = 1.5 \cdot V_R$ typ.: $f = 10\text{ kHz}$			0.1	A

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$I_{RMS}$	RMS current	per pin <sup>1)</sup>			35	A
$R_{thCH}$	thermal resistance case to heatsink			0.50		K/W
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				2		g
$M_D$	mounting torque		0.4		0.8	Nm
$F_c$	mounting force with clip		20		60	N

<sup>1)</sup>  $I_{RMS}$  is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.

In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

### Product Marking



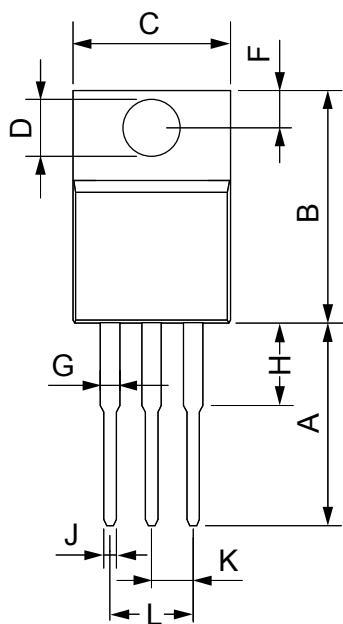
### Part number

D = Diode  
 S = Schottky Diode  
 A = low VF  
 30 = Current Rating [A]  
 C = Common Cathode  
 150 = Reverse Voltage [V]  
 PB = TO-220AB (3)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DSA 30 C 150 PB	DSA30C150PB	Tube	50	505443

Similar Part	Package	Voltage class
DSA30C150HB	TO-247	150

## Outlines TO-220



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	12.70	13.97	0.500	0.550
B	14.73	16.00	0.580	0.630
C	9.91	10.66	0.390	0.420
D	3.54	4.08	0.139	0.161
E	5.85	6.85	0.230	0.270
F	2.54	3.18	0.100	0.125
G	1.15	1.65	0.045	0.065
H	2.79	5.84	0.110	0.230
J	0.64	1.01	0.025	0.040
K	2.54	BSC	0.100	BSC
M	4.32	4.82	0.170	0.190
N	1.14	1.39	0.045	0.055
Q	0.35	0.56	0.014	0.022
R	2.29	2.79	0.090	0.110